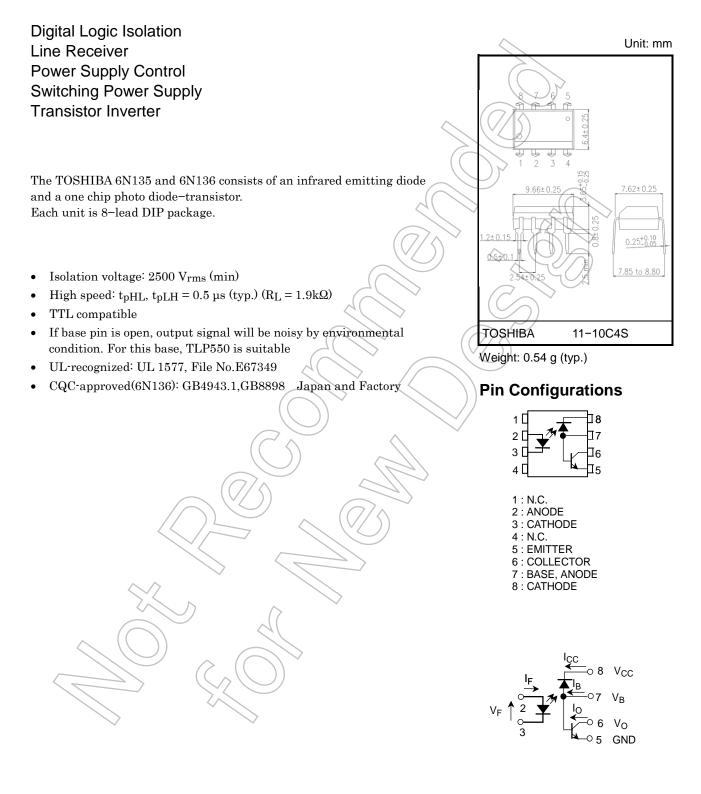
# TOSHIBA

TOSHIBA Photocoupler IRED & Photo IC

# 6N135, 6N136



Absolute Maximum Ratings (Ta = 25°C)

	Characteristics	Symbol	Rating	Unit		
LED	Forward current	(Note 1)	lF	25	mA	
	Pulse forward current	(Note 2)	l <sub>FP</sub>	50	mA	
	Total pulse forward current	(Note 3)	IFPT	1	A	
	Reverse voltage		VR	5	V	$\sim$
	Diode power dissipation	(Note 4)	PD	45	mW	$\sum r$
Detector	Output current		lo	8	mA	
	Peak output current		lop	16	mA	))
	Emitter-base reverse voltage (p	oin 5–7)	VEB	5		
	Supply voltage		Vcc	-0.5 to 15	V	
	Output voltage		Vo	-0.5 to 15	×	$\bigcirc$
	Base current (pin 7)		IB	5	mA	
	Output power dissipation	(Note 5)	Po	100	mW	6
Operating temperature range			Topr	-55 to 100	°C	
Storage temperature range		T <sub>stg</sub>	-55 to 125	°C		
Lead solder temperature (10s) (Note 6)			Tsol	260	°¢	$a^{\vee}$
Isolation voltage (Note 7)		BVs	2500	Vrms	I I	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

- (Note 1) Derate 0.8 mA above 70°C.
- (Note 2) 50 % duty cycle, 1 ms pulse width. Derate 1.6 mA / °C above 70 °C.
- (Note 3) Pulse width 1µs, 300pps.
- (Note 4) Derate 0.9 mW / °C above 70 °C.
- (Note 5) Derate 2 mW / °C above 70 °C.
- (Note 6) Soldering portion of lead: Up to 2 mm from the body of the device.
- (Note 7) R.H. ≤ 60 %, AC, 60 s

### **Electrical Characteristics**

## Over Recommended Temperature (Ta = 0°C~70°C unless otherwise noted)

Characteristics		Symbol	Test Condition	Min	(**)Typ.	Max	Unit
	6N135	CTR	I <sub>F</sub> = 16 mA, V <sub>O</sub> = 0.4 V	7	18	_	%
Current transfer ratio 6N136 6N135		CIR	$V_{CC} = 4.5 V$ , Ta = 25 °C (Note 8)	19	24		%
		CTR	IF = 16 mA, Vo = 0.5 V	5	13	_	%
	6N136	UIK	V <sub>CC</sub> = 4.5 V (Note 1)	15	21		%
Logic low output voltage	6N135	Vol	IF = 16 mA, IO = 1.1 mA V <sub>CC</sub> = 4.5 V		0.1	0.4	V
Logic low output voltage	6N136	VOL	IF = 16 mA, IO = 2.4 mA V <sub>CC</sub> = 4.5 V		0.1	0.4	V
		leu	IF = 0 mA, V <sub>O</sub> = V <sub>CC</sub> = 5.5 V Ta = 25 °C	_	3	500	nA
Logic high output current		ЮН	IF = 0 mA, V <sub>O</sub> = V <sub>CC</sub> = 15 V Ta = 2 5 °C	- 2	0.1	$>_1$	μΑ
		Юн	IF = 0 mA, VO = VCC = 15 V	- <del>(</del> C	))	50	μΑ
Logic low supply current		ICCL	IF = 16 mA, Vo = open V <sub>CC</sub> = 15 V	ľ,	40	_	μA
Logic high supply current		Іссн	IF = 0 mA, V <sub>O</sub> = open V <sub>CC</sub> = 15 V, Ta = 25 °C	$\widehat{\mathcal{F}}$	0.01	1	μA
		Іссн	IF = 0 mA, V <sub>O</sub> = open V <sub>CC</sub> = 15 V		_	2	μΑ
Input forward voltage		VF	l⊧ = 16m A, Ta <i>=</i> 25 °C	_	1.65	1.7	V
Temperature coefficient of forward voltage		$\Delta V_{F} / \Delta Ta$	lp= 16 mA	_	-1.9	_	mV / °C
Input reverse breakdown volta	ge	BVR	I <sub>R</sub> = 10 μA, Ta = 25 °C	5	_	_	V
Input capacitance	(	CIN	f = 1 MHz, VF = 0 V	_	60	_	pF
Resistance (input-output)		RI-O	V <sub>I–O</sub> = 500 V (Note 9) R.H. ≤ 60 %	_	10 <sup>12</sup>	_	Ω
Capacitance (input-output)		) CI–O	f = 1 MHz, V = 0 V (Note 9)		0.6	_	pF
Transistor DC current gain hFE			$V_0 = 5 V, I_0 = 3 \text{ mA}$	_	80	_	—

(\*\*) All typical values are at Ta = 25 °C

#### **Switching Specifications**

#### (unless otherwise specified. Ta = 25°C, Vcc = 5V, IF = 16mA)

Characteristics	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit	
Propagation delay time	6N135	tpHL	1	R <sub>L</sub> = 4.1 kΩ	—	0.2	1.5	μs
to logic low at output	6N136			R <sub>L</sub> = 1.9 kΩ	γ	0.2	0.8	μs
Propagation delay time	6N135	<sup>t</sup> pLH	1	$R_L = 4.1 \text{ k}\Omega$		1.0	1.5	μs
to logic high at output	6N136			R <sub>L</sub> = 1.9 kΩ	$\mathbb{D}$	0.5	0.8	μs
Common mode transient immunity	6N135	CMH	2		5)-	1000	_	V / µs
at logic high level output (Note 10)	6N136				_	1000	_	V / µs
Common mode transient immunity	6N135	CML	2	$V_{CM} = 10 V_{p=p}$ $R_L = 4.1 k\Omega$ $I_F = 16 mA$	-2	-1000		V / µs
at logic low level output (Note 10)	6N136			$V_{CM} = 10 V_{p-p}$ $R_L = 1.9 k\Omega$ $I_F = 16 mA$	$\left(\begin{array}{c} 0\\ 7\\ \end{array}\right)$	-1000	_	V / µs
Bandwidth	(Note 11)	BW	_	R <sub>L</sub> =100 Ω		2	_	MHz

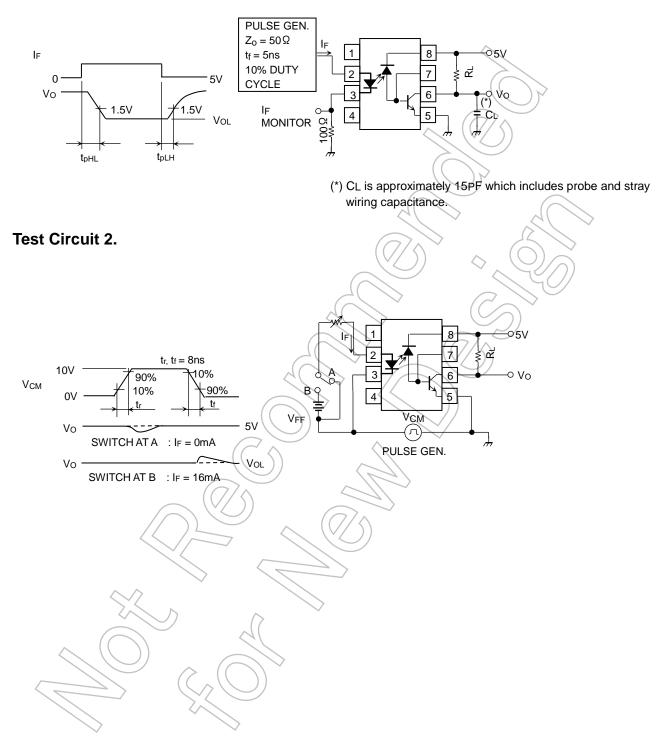
- (Note 8) DC current transfer ratio is defined as the ratio of output collector current, IO, to the forward LED input current, IF, times 100 %.
- (Note 9) Device considered a two-terminal device: Pins 1, 2, 3 and 4 shorted together and pins 5, 6, 7 and 8 shorted together.
- (Note 10) Common mode transient immunity in logic high level is the maximum tolerable (positive) dVCM / dt on the leading edge of the common mode pulse, VCM, to assure that the output will remain in a logic high state (i.e., VO > 2.0 V).

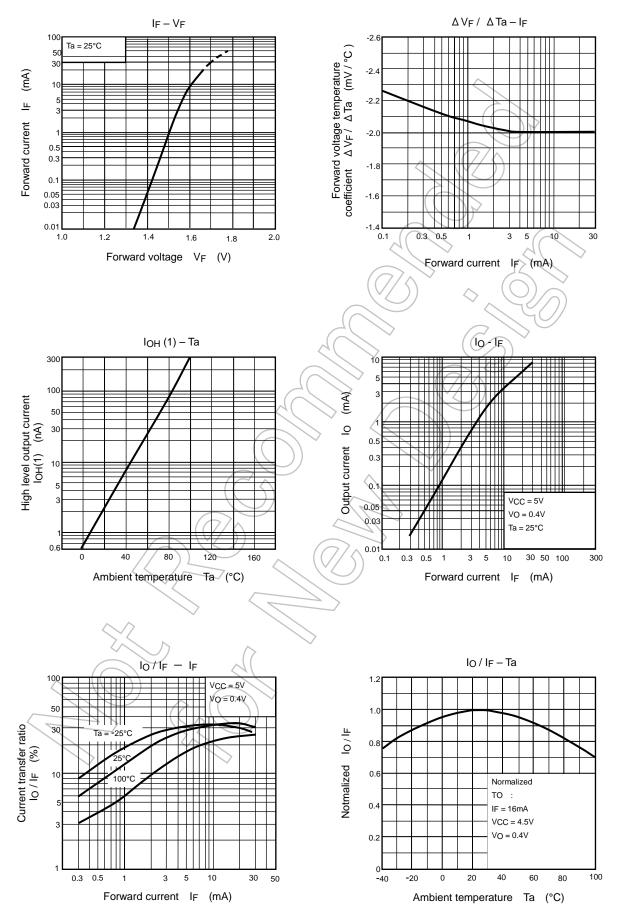
Common mode transient immunity in logic low level is the maximum tolerable (negative) dVCM / dt on the trailing edge of the common mode pulse signal, VCM, to assure that the output will remain in a logic low state (i.e., VO < 0.8 V).

(Note 11) The frequency at which the AC output voltage is 3dB below the low frequency asymptote.

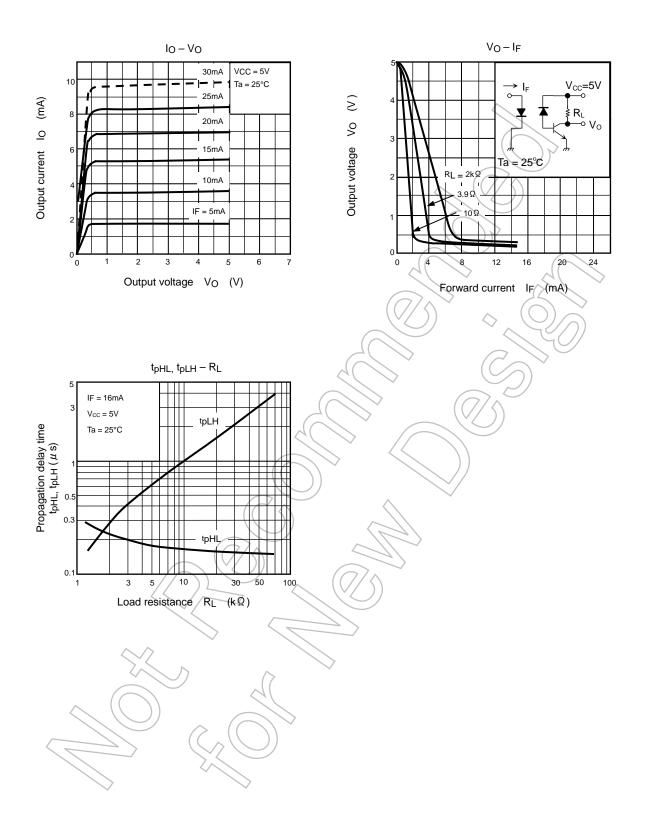
# TOSHIBA

### Test Circuit 1.





NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

#### **RESTRICTIONS ON PRODUCT USE**

Toshiba Corporation and its subsidiaries and affiliates are collectively referred to as "TOSHIBA". Hardware, software and systems described in this document are collectively referred to as "Product".

- TOSHIBA reserves the right to make changes to the information in this document and related Product without notice.
- This document and any information herein may not be reproduced without prior written permission from TOSHIBA. Even with TOSHIBA's written permission, reproduction is permissible only if reproduction is without alteration/omission.
- Though TOSHIBA works continually to improve Product's quality and reliability, Product can malfunction or fail. Customers are responsible for complying with safety standards and for providing adequate designs and safeguards for their hardware, software and systems which minimize risk and avoid situations in which a malfunction or failure of Product could cause loss of human life, bodily injury or damage to property, including data loss or corruption. Before customers use the Product, create designs including the Product, or incorporate the Product into their own applications, customers must also refer to and comply with (a) the latest versions of all relevant TOSHIBA information, including without limitation, this document, the specifications, the data sheets and application notes for Product and the precautions and conditions set forth in the "TOSHIBA Semiconductor Reliability Handbook" and (b) the instructions for the application with which the Product will be used with or for. Customers are solely responsible for all aspects of their own product design or applications; (b) evaluating and determining the applicability of any information contained in this document, or in charts, diagrams, programs, algorithms, sample application circuits, or any other referenced documents; and (c) validating all operating parameters for such designs and applications. TOSHIBA ASSUMES NO LIABILITY FOR CUSTOMERS' PRODUCT DESIGN OR APPLICATIONS.
- PRODUCT IS NEITHER INTENDED NOR WARRANTED FOR USE IN EQUIPMENTS OR SYSTEMS THAT REQUIRE EXTRAORDINARILY HIGH LEVELS OF QUALITY AND/OR RELIABILITY, AND/OR A MALFUNCTION OR FAILURE OF WHICH MAY CAUSE LOSS OF HUMAN LIFE, BODILY INJURY, SERIOUS PROPERTY DAMAGE AND/OR SERIOUS PUBLIC IMPACT ("UNINTENDED USE"). Except for specific applications as expressly stated in this document, Unintended Use includes, without limitation, equipment used in nuclear facilities, equipment used in the aerospace industry, lifesaving and/or life supporting medical equipment, equipment used for automobiles, trains, ships and other transportation, traffic signaling equipment, equipment used to control combustions or explosions, safety devices, elevators and escalators, and devices related to power plant. IF YOU USE PRODUCT FOR UNINTENDED USE, TOSHIBA ASSUMES NO LIABILITY FOR PRODUCT. For details, please contact your TOSHIBA sales representative or contact us via our website.
- Do not disassemble, analyze, reverse-engineer, alter, modify, translate or copy Product, whether in whole or in part.
- Product shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable laws or regulations.
- The information contained herein is presented only as guidance for Product use. No responsibility is assumed by TOSHIBA for any infringement of patents or any other intellectual property rights of third parties that may result from the use of Product. No license to any intellectual property right is granted by this document, whether express or implied, by estoppel or otherwise.
- ABSENT A WRITTEN SIGNED AGREEMENT, EXCEPT AS PROVIDED IN THE RELEVANT TERMS AND CONDITIONS OF SALE FOR PRODUCT, AND TO THE MAXIMUM EXTENT ALLOWABLE BY LAW, TOSHIBA (1) ASSUMES NO LIABILITY WHATSOEVER, INCLUDING WITHOUT LIMITATION, INDIRECT, CONSEQUENTIAL, SPECIAL, OR INCIDENTAL DAMAGES OR LOSS, INCLUDING WITHOUT LIMITATION, LOSS OF PROFITS, LOSS OF OPPORTUNITIES, BUSINESS INTERRUPTION AND LOSS OF DATA, AND (2) DISCLAIMS ANY AND ALL EXPRESS OR IMPLIED WARRANTIES AND CONDITIONS RELATED TO SALE, USE OF PRODUCT, OR INFORMATION, INCLUDING WARRANTIES OR CONDITIONS OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, ACCURACY OF INFORMATION, OR NONINFRINGEMENT.
- GaAs (Gallium Arsenide) is used in Product. GaAs is harmful to humans if consumed or absorbed, whether in the form of dust or vapor. Handle with care and do not break, cut, crush, grind, dissolve chemically or otherwise expose GaAs in Product.
- Do not use or otherwise make available Product or related software or technology for any military purposes, including without
  limitation, for the design, development, use, stockpiling or manufacturing of nuclear, chemical, or biological weapons or missile
  technology products (mass destruction weapons). Product and related software and technology may be controlled under the
  applicable export laws and regulations including, without limitation, the Japanese Foreign Exchange and Foreign Trade Law and the
  U.S. Export Administration Regulations. Export and re-export of Product or related software or technology are strictly prohibited
  except in compliance with all applicable export laws and regulations.
- Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. Please use Product in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive. TOSHIBA ASSUMES NO LIABILITY FOR DAMAGES OR LOSSES OCCURRING AS A RESULT OF NONCOMPLIANCE WITH APPLICABLE LAWS AND REGULATIONS.

# **TOSHIBA ELECTRONIC DEVICES & STORAGE CORPORATION**

https://toshiba.semicon-storage.com/

# **Mouser Electronics**

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Toshiba: 6N136F 6N136(TP1F)